onsemi

<u>MOSFET</u> – Power, N-Channel, Automotive SUPERFET[®] III, Easy-drive 650 V, 75 A, 25 mΩ

NVHL025N65S3

Description

SuperFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss provide superior switching performance, and with-stand extreme dv/dt rate. Consequently, SuperFET III MOSFET Easy-drive series helps manage EMI issues and allows for easier design implementation.

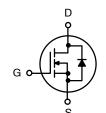
Features

- AEC-Q101 Qualified
- Max Junction Temperature 150°C
- Typ. $R_{DS}(on) = 19.9 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_G = 236 \text{ nC}$)
- Low Effective Output Capacitance (Typ. C_{OSS}(eff.) = 2062 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Typical Applications

- Automotive PHEV-BEV DC-DC Converter
- Automotive Onboard Charger for PHEV-BEV

BV _{DSS}	R _{DS(on)} MAX	I _D MAX
650 V	25 mΩ @ 10 V	75 A

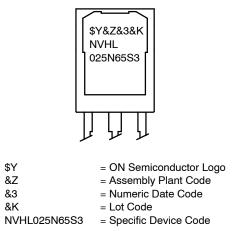


N-Channel MOSFET



TO-247-3LD CASE 340CX

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol		Parameter		Unit	
V _{DSS}	Drain to Source Voltage		650	V	
V _{GSS}	Gate to Source Voltage	DC Positive	30	V	
		AC Positive, (f > 1 Hz)	30	V	
		AC Negative, (f > 1 Hz)	-20	V	
I _D	Drain Current	Continuous (Tc = 25°C)	75	Α	
		Continuous (Tc = 100°C)	65.8	Α	
I _{DM}	Pulsed Drain Current	Pulsed (Note 1)	300	Α	
E _{AS}	Single Pulsed Avalanche Energy (N	e Energy (Note 2)		mJ	
E _{AR}	Repetitive Avalanche (Note 1)		5.95	mJ	
dv/dt	MOSFET dv/dt	OSFET dv/dt 100		V/ns	
	Peak Diode Recovery dv/dt (Note 3	3)	20	V/ns	
PD	Power Dissipation	(Tc = 25°C)	595	W	
		Derate Above 25°C	4.76	W/°C	
T _J ,T _{STG}	Operating and Storage Temperatur	e Range	–55 to +150	°C	
TL	Maximum Lead Temperature for So	oldering, 1/8" from Case for 5 Seconds	300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 15 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}C$. 3. $I_{SD} < 75 \text{ A}, \text{ di/dt} \le 200 \text{ A/ms}, \text{ VDD} \le \text{BVDSS}$, starting $T_J = 25^{\circ}C$.

4. Essentially independent of operating temperature typical characteristics.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R _{θJ C}	Thermal Resistance, Junction to Case, Max	0.21	°C/W
R _{θJ A}	Thermal Resistance, Junction to Ambient, Max	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Shipping (Qty / Packing)
NVHL025N65S3	NVHL025N65S3	TO-247-3LD	Tube	30 Units / Tube

ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit			
DFF CHARACTERISTICS									
BV _{DSS}	Drain-to-Source Breakdown Voltage	V_{GS} = 0 V, I _D = 1 mA, T _J = 25°C	650	713	-	V			
		V_{GS} = 0 V, I_D = 1 mA, T_J = 150°C	650	755	-	V			
$\Delta BVDSS / \Delta TJ$	Breakdown Voltage Temperature Coefficient	$I_D = 1 \text{ mA}$, Referenced to 25°C	-	0.34	-	V/°C			
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	-	0.30	1	μA			
		V_{DS} = 520 V, V_{GS} = 0 V, Tc = 125 $^\circ \text{C}$	-	7.92	-				
I _{GSS}	Gate to Body Leakage Current	V_{GS} = +30 V, V_{DS} = 0 V	_	5.27	+100	nA			
		$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	-	2.65	-100	nA			

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 3.0 \text{ mA}$	2.5	3.56	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I_{D} = 37.5 A, T_{J} = 25°C	-	19.9	25	mΩ
		V_{GS} = 10 V, I _D = 37.5 A, T _J = 100°C	-	34.6	-	mΩ
9fs	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 75 \text{ A}$	Ι	78.5	-	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	-	7330	-	pF
C _{oss}	Output Capacitance		-	197	-	pF
C _{rss}	Reverse Transfer Capacitance		-	33.6	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	2062	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	285	-	pF
Q _{g(tot)}	Total Gate Charge	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 75 \text{ A}$	-	236	-	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	59.3	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	97.3	-	nC
R _G	Gate Resistance	f = 1 MHz	-	0.818	-	Ω

SWITCHING CHARACTERISTICS

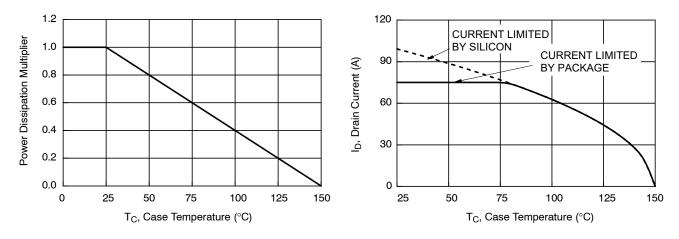
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 75 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	43.3	-	ns
t _r	Turn-On Rise Time	R _G = 2 Ω (Note 4)	-	109	-	ns
t _{d(off)}	Turn-Off Delay Time		-	120	-	ns
t _f	Fall Time		-	107	-	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

۱ _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	75	А
I _{SM}	Maximum Plused Drain to Source Diode Forward Current		-	-	300	А
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 37.5 A	-	0.88	1.2	V
t _{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 75 A dI _F /dt = 100 A/µs	-	714	-	nS
Q _{rr}	Reverse Recovery Charge		-	26.4	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



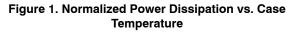


Figure 2. Maximum Continuous Drain Current vs. Case Temperature

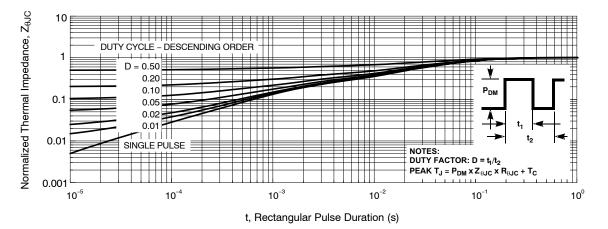
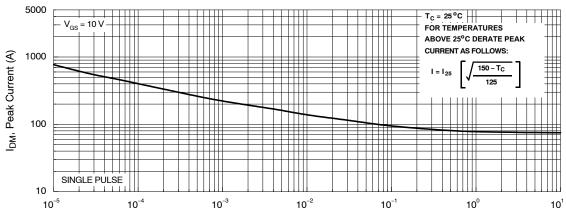


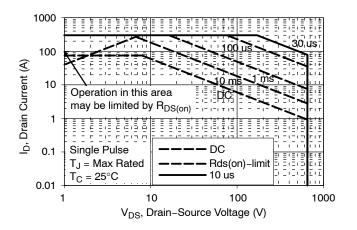
Figure 3. Normalized Maximum Transient Thermal Impedance



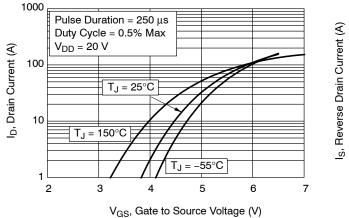
t, Rectangular Pulse Duration (s)

Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (continued)









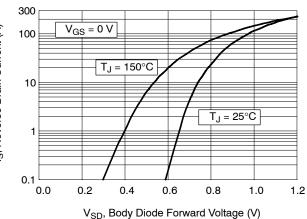
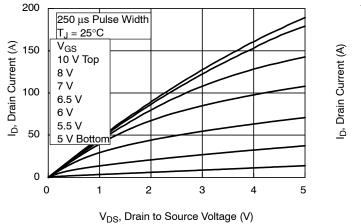


Figure 7. Forward Diode Characteristics





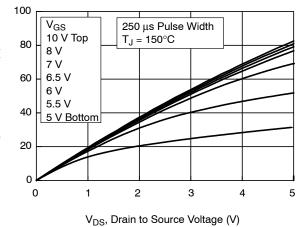
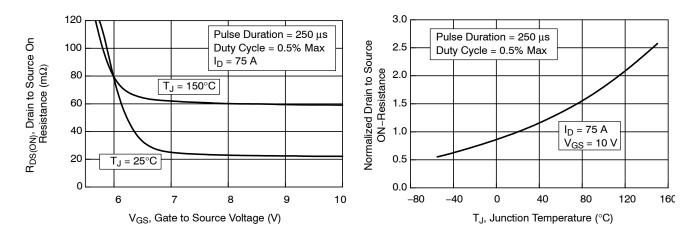


Figure 9. Saturation Characteristics

TYPICAL CHARACTERISTICS (continued)



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Figure 10. R_{DSON} vs. Gate Voltage



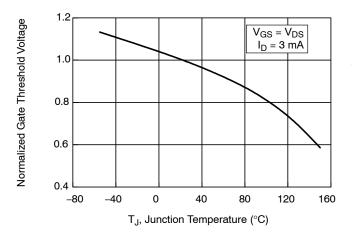
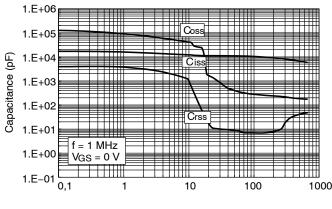


Figure 12. Normalized Gate Threshold Voltage vs. Temperature



V_{DS}, Drain to Source Voltage (V)

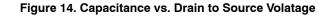


Figure 13. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

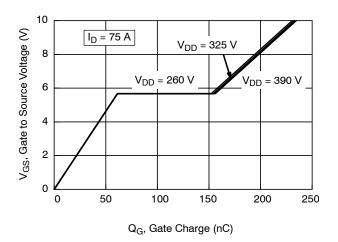
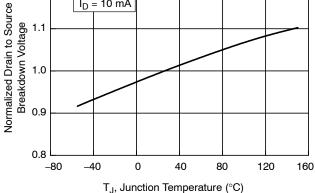


Figure 15. Gate Charge vs. Gate to Source Voltage

I_D = 10 mA



TYPICAL CHARACTERISTICS (continued)

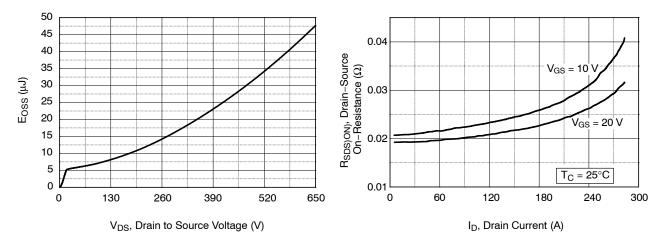


Figure 16. E_{OSS} vs. Drain to Source Voltage

Figure 17. On–Resistance Variation vs. Drain Current and Gate Voltage

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